TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOS III)

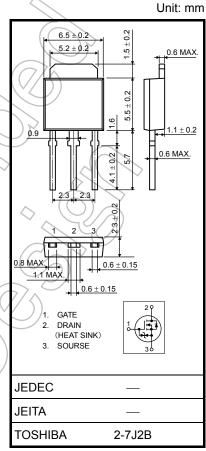
2SK4017

Chopper Regulator, DC-DC Converter and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON-resistance: $R_{DS (ON)} = 0.07 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 6.0 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 60 V)
- Enhancement mode: V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	60	V
Drain-gate voltage (Ro	_{GS} = 20 kΩ)	V_{DGR}	60	> V
Gate-source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	ΙD	5	Α
	Pulse (Note 1)	I _{DP} <	20	A
Drain power dissipation	n (Tc = 25°C)	PD	20	√w.
Single-pulse avalanche	e energy (Note 2)	EAS	40.5	mJ
Avalanche current		(IAR (5	(A
Repetitive avalanche e	energy (Note 3)	EAR	2	mJ
Channel temperature	((7/⟨T _{ch}	150	°C
Storage temperature ra	ange	T _{stg}	-55 to 150	°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C / W

- Note 1: Ensure that the channel temperature does not exceed 150°C.
- Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 2.2 mH, R_G = 25 Ω , I_{AR} = 5 A
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

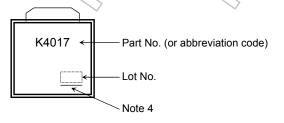
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μА
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source breakdown voltage		V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V
		V (BR) DSX	I _D = 10mA, V _{GS} = -20V	35	1	_	V
Gate threshold v	/oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.3))/_	2.5	V
Drain-source ON-resistance		Pro (OV)	V _{GS} = 4 V, I _D = 2.5 A) 	0.09	0.15	Ω
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	\mathcal{L}	0.07	0.10	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	3.0	6.0	_	S
Input capacitano	ce	C _{iss}		_	730	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF
Output capacitance		Coss		- /	95	\searrow	
Switching time	Rise time	t _r	V _{cs} 0V 10V 15=2.5A 00UT	\(\frac{1}{2}\)	10	> -	
	Turn-on time	t _{on}	0V R _t =12Ω		20	_	ns
	Fall time	t _f	V _{DD} ≈ 30V		4	_	115
	Turn-off time	t _{off}	Duty≤1%, t _w =10 μs) _	35	_	
Total gate charg plus gate-drain)		Q _g (_	15	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	_	11	_	nC
Gate-drain ("Miller") charge		Qgd		_	4	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	loo /	_			5	A
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	D _R = 5 A, V _{GS} = 0 V, dl _{DR} / dt = 50 A / μs	_	34	_	ns
Reverse recovery charge	Qrr	1DR - 3 A, VGS - 0 V, αιDR / αι - 30 A / μs	_	28	_	nC

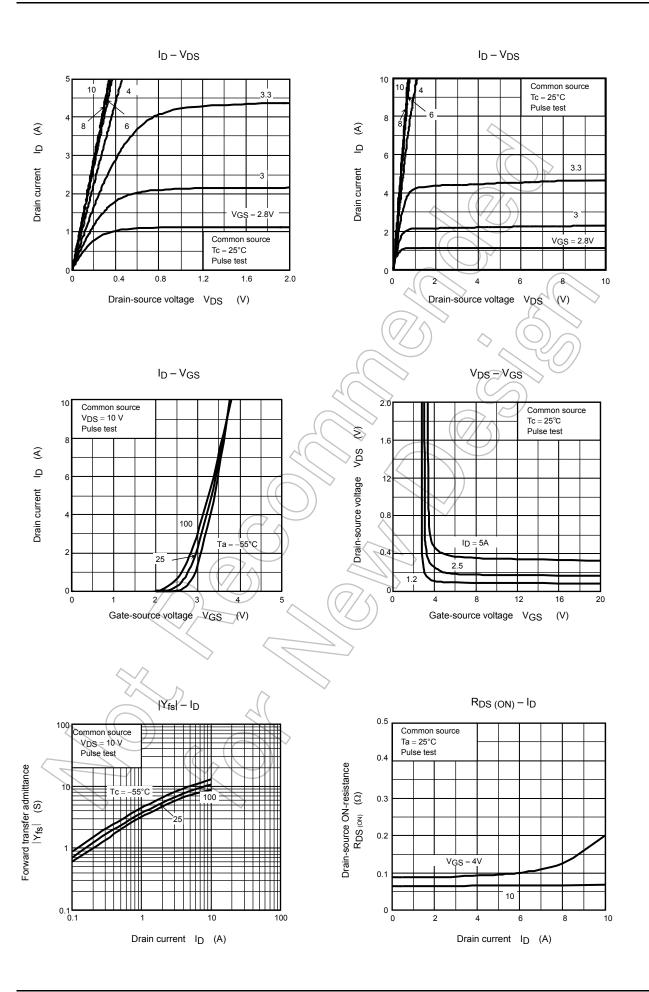


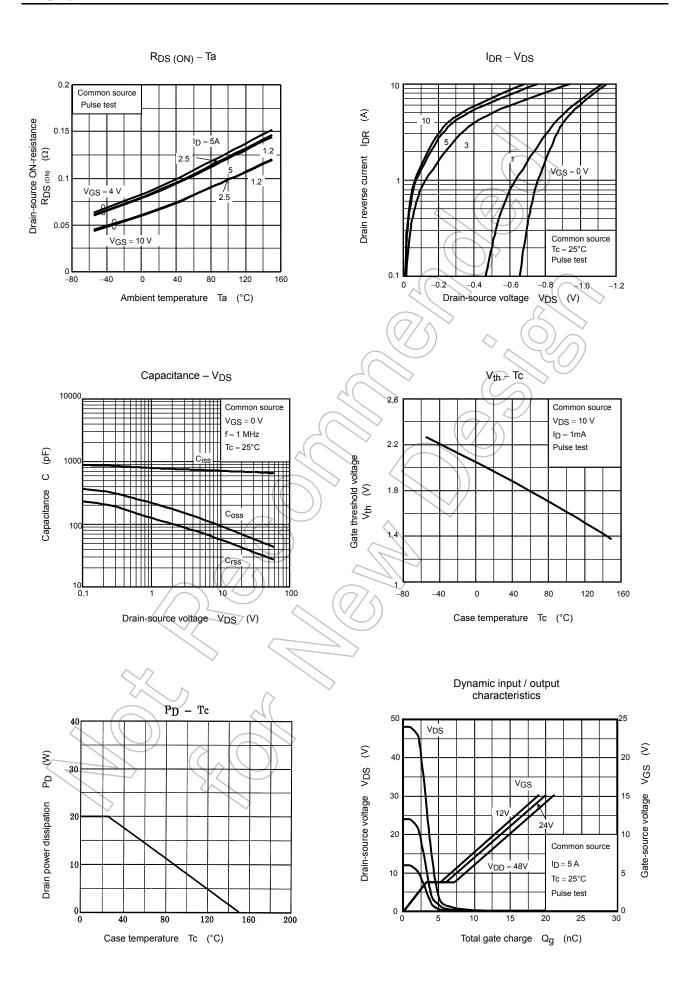


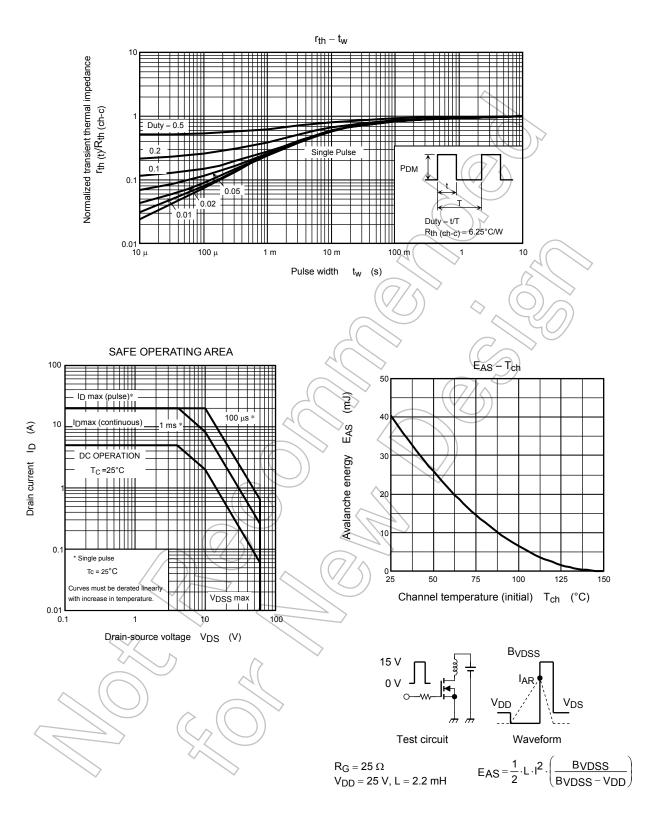
Note 4: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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